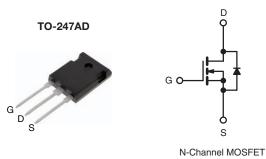
## SiHW47N60EF



**Vishay Siliconix** 

## **EF Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.065		
Q <sub>g</sub> max. (nC)	228			
Q <sub>gs</sub> (nC)	32			
Q <sub>gd</sub> (nC)	62			
Configuration	Single			



#### **FEATURES**

- Fast body diode MOSFET using E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Increased robustness due to low Q<sub>rr</sub>
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High-intensity lighting (HID)
  - Light emitting diodes (LEDs)
- Consumer and computing
- ATX power supplies
- Industrial
  Welding
  - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switching mode power supplies (SMPS)
- Applications using the following topologies
- LLC
- Phase shifted bridge (ZVS)
- 3-level inverter
- AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW47N60EF-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	600	V			
Gate-Source Voltage			V <sub>GS</sub>	± 30	l v		
Continuous Drain Current ( $T_J = 150 \ ^\circ C$ )	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub> -	47			
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		29	А		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	138			
Linear Derating Factor				3	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	1500	mJ		
Maximum Power Dissipation			P <sub>D</sub>	379	W		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C			
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		-1) / /-14	70	)///		
Reverse Diode dV/dt <sup>d</sup>		dV/dt	11	V/ns			
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s			300	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 73.5 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 6.4$  A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , dI/dt = 100 A/µs, starting  $T_J$  = 25 °C.

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COMPLIANT

HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		40				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	- 0.33			°C/W		
<b>SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ , u		ise noted)						1
PARAMETER	SYMBOL	TES		DNS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 2	50 µA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I	<sub>0</sub> = 1 mA	-		-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \mu A$			-	4.0	V
		$V_{GS} = \pm 20 V$		-	-	± 100	nA	
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 \	/	-	-	± 1	μA
		V <sub>DS</sub> =	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	ID	= 24 A	-	0.056	0.065	Ω
Forward Transconductance		V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	24 A	-	17	-	S
Dynamic					<u> </u>	1	<u></u>	1
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V, V_{DS} = 100 V, f = 1 MHz$		-	5000	-	pF	
Output Capacitance	Coss			-	220	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	7	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	172	-		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	634	-		
Total Gate Charge	Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 24 A, V <sub>DS</sub> = 480 V		-	152	228	nC	
Gate-Source Charge	Q <sub>gs</sub>			-	32	-		
Gate-Drain Charge	Q <sub>gd</sub>				-	62	-	1
Turn-On Delay Time	t <sub>d(on)</sub>			-	30	60		
Rise Time	t <sub>r</sub>	Vpp -	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 24 A,		-	56	84	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 24 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.4 \Omega$		-	91	137	- ns	
Fall Time	t <sub>f</sub>			-	56	84		
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.46	-	Ω	
Drain-Source Body Diode Characteristic	S							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	47		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	138	A	
Diode Forward Voltage	V <sub>SD</sub>	$T_{J} = 25 \text{ °C}, I_{S} = 24 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.9	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 24 \text{ A},$ $dI/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 25 \text{ V}$		-	199	398	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.4	2.8	μC	
Reverse Recovery Current	I <sub>RRM</sub>			_	13.2	_	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

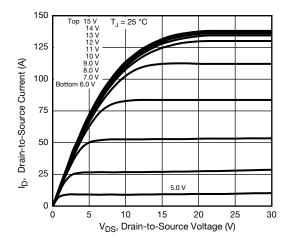


Fig. 1 - Typical Output Characteristics

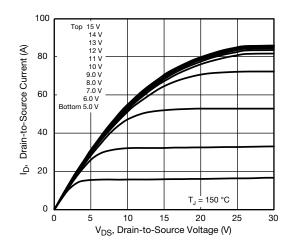
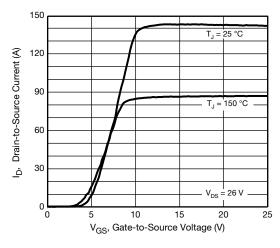


Fig. 2 - Typical Output Characteristics





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3.0 I<sub>D</sub> = 24 A R<sub>DS(on)</sub>, Drain-to-Source On Resistance (Normalized) 2.5 2.0 1.5 1.0 0.5 = 10 V V<sub>GS</sub> 0.0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

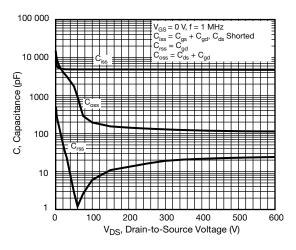
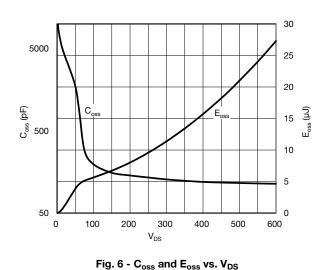


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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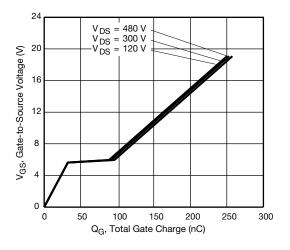


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

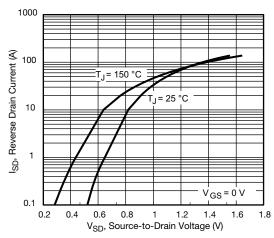


Fig. 8 - Typical Source-Drain Diode Forward Voltage

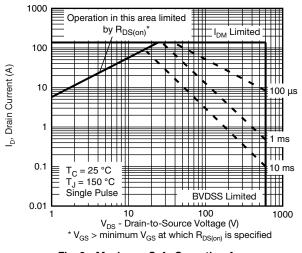


Fig. 9 - Maximum Safe Operating Area

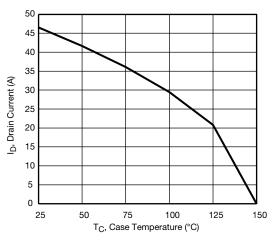


Fig. 10 - Maximum Drain Current vs. Case Temperature

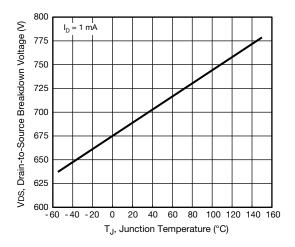
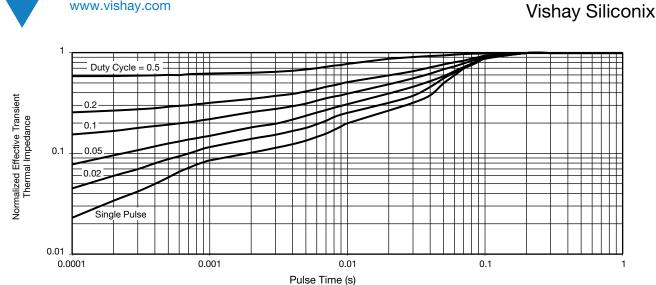
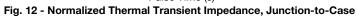
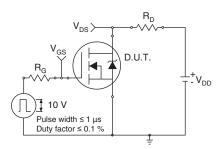


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

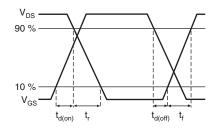


Fig. 14 - Switching Time Waveforms

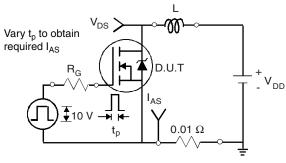


Fig. 15 - Unclamped Inductive Test Circuit

V<sub>DS</sub>  $V_{\text{DD}}$ V<sub>DS</sub>  $I_{AS}$ 

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Fig. 16 - Unclamped Inductive Waveforms

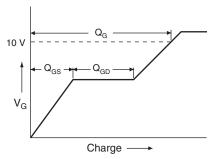


Fig. 17 - Basic Gate Charge Waveform

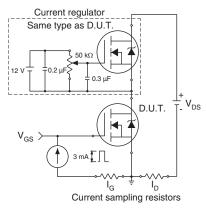


Fig. 18 - Gate Charge Test Circuit

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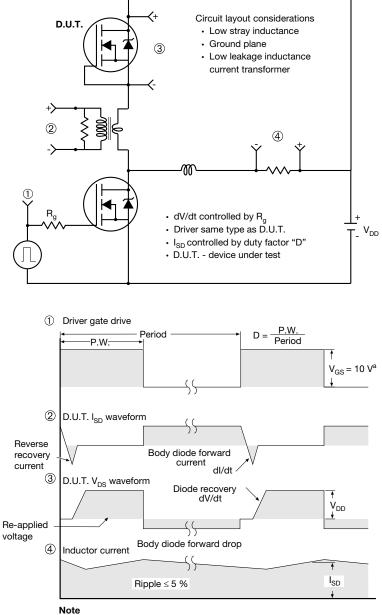
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 18 - For N-Channel

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